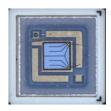
CUSTOMER:

DATE :

REV : REV. 0.0 .

preliminary

# SPECIFICATIONS FOR APPROVAL



### 365nm 1in1 UV LED PKG

MODEL NAME: LEUVA66X00RV00



APPROVAL	REMARK	APPENDIX

DESIGNED	CHECKED	APPROVED
		_



### **CONTENTS**

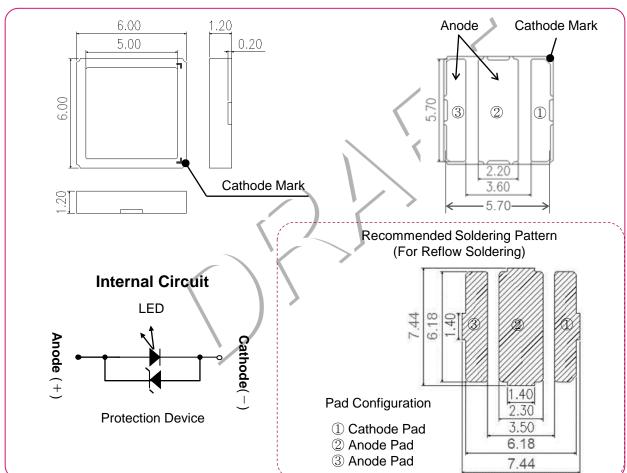
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### 1. Features

- Lighting Color(Peak Wavelength): 365nm
- Surface Mount Type: 6.0×6.0×1.2 (L×W×H, Unit: mm)
- Viewing Angle(Directivity): Typical 120°
- Soldering Methods: Pb-Free IR-Reflow Soldering

### 2. Outline Dimensions

(Unit:mm)



Tolerance unless otherwise mentioned are  $\pm 0.20$  mm

### 3. Applications

- UV Curing, UV Ink Curing, Photo-Catalyst, Sensor Light, etc.

### 4. Absolute Maximum Ratings

(Ta= 25 °C)

Items	Symbols	Ratings	Unit
Forward Current	If	2.0	Α
Power Dissipation	Pd	8.2	W
Operating Temperature	Topr	-10 ~ +85	$^{\circ}$
Storage Temperature	Tstg	-40 ~ +100	$^{\circ}$
Junction Temperature	Tj	<125	${\mathbb C}$
Soldering Temperature	JEDEC-J-STD-020D		
ESD Classification	Class 2 (JESD22-A114)		

<sup>\*\*</sup> Operating the LED beyond the listed maximum ratings may affect device reliability and cause permanent damage. These or any other conditions beyond those indicated under recommended operating conditions are not implied. The exposure to the absolute maximum rated conditions may affect device reliability.

### 5. Electro-Optical Characteristics

(Ta= 25 °C)

Items	Symbol	Condition	Target Spec.			Unit
items	Symbol	Condition	Min.	Тур.	Max.	Onit
Forward Voltage	Vf		3.3	3.7	4.1	V
Radiant Flux	Фе	>	-	2060	-	mW
Peak Wavelength	$\lambda_{P}$	If = 1.5 A	360	365	370	nm
Spectrum Half Width	$\triangle \mathbf{\lambda}$	II = 1.5 A	-	13	-	nm
Viewing Anlge	2Θ1/2		-	120	-	deg
Thermal Resistance *1)	Rth j-c		-	-	-	°C/W

<sup>\*1)</sup> Rthj-c = Thermal Resistance (Junction – Case)

- Forward Voltage(Vf) :  $\pm 0.1 \text{V}$ 

- Peak Wavelength( $\lambda p$ ) :  $\pm 3.0$ nm

<sup>\*</sup> Although all LEDs are tested by LG Innotek equipment, some values may vary slightly depending on the conditions of the test equipment.



<sup>\*</sup> The LEDs are not designed to be driven in reverse bias.

<sup>\*</sup> These values are measured by the LG Innotek optical spectrum analyzer within the following tolerances.

<sup>-</sup> Radiant Flux(Φe) : ±10%

### 6. Bin Structures

Items	Rank	Min.	Max.	Unit
Peak Wavelength	R	360	370	nm
Radiant Flux	TBD	2060		mW
	V4	3.9	4.1	
Converd Velters	V3	3.7	3.9	V
Forward Voltage	V2	3.5	3.7	V
	V1	3.3	3.5	

※ Forward Current = 1.5A

\* Rank name method : Please refer to the following example

Rank Name: R-GP09-V2

- Peak Wavelength = R

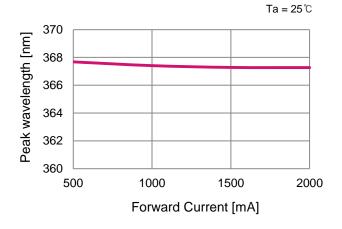
- Radiant Flux = GP09

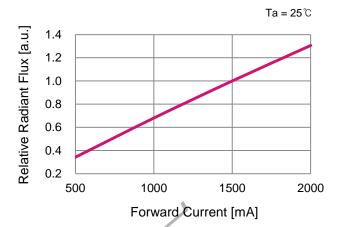
- Forward Voltage = V2

### 7. Typical Characteristic Curves

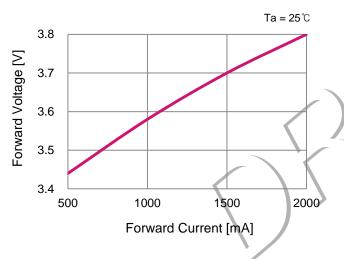
- Forward Current vs. Peak Wavelength

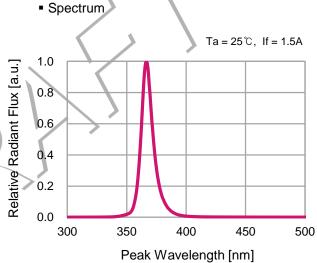
Forward Current vs. Relative Radiant Flux



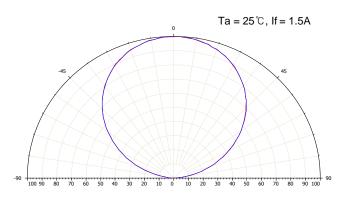


■ Forward Current vs. Forward Voltage





Radiation Characteristics (Angle of Beam Spread, Directivity)

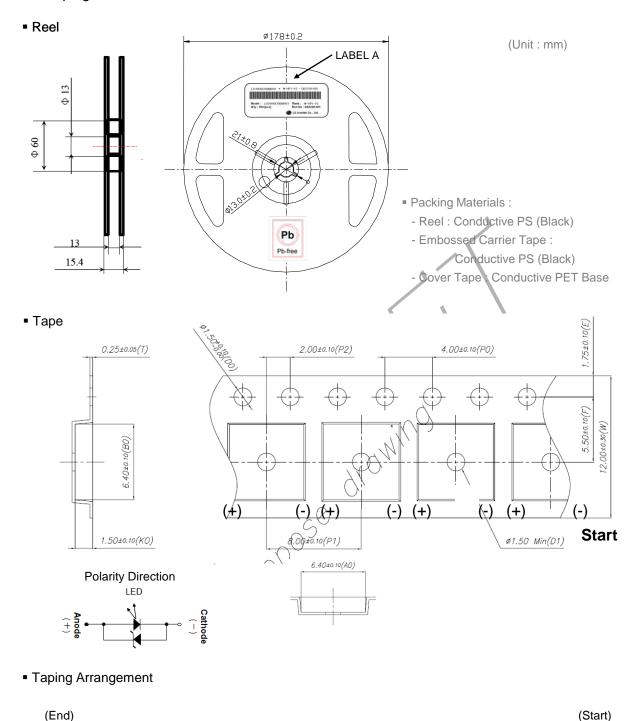


### 8. Packing and Labeling of Products

### 8-1. Taping Outline Dimensions

More than 40mm

unloaded tape



150 ~ 600mm

Leading part

More than 40mm

unloaded tape

Mounted with LED

(500ea)

### 8. Packing and Labeling of Products

#### 8-2. Package and Label Structure

\*. Label A

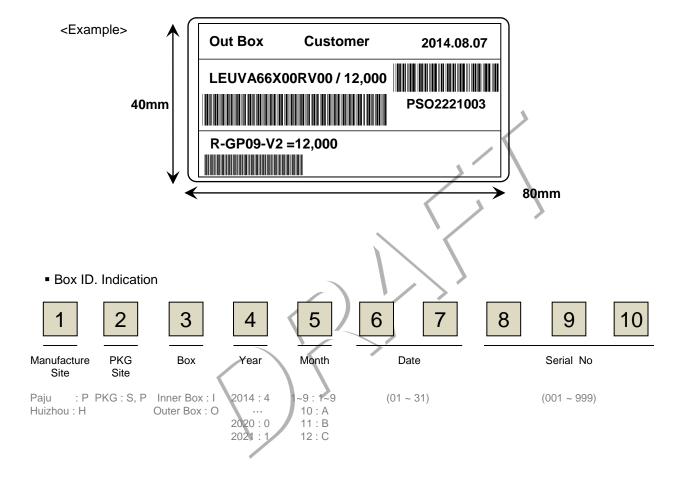
#### Specifying Model Name, Rank, Rack, Quantity and Run number <Example> LEUVA66X00RV00=R-GP09-V2=O94822-054 40mm Model: LEUVA66X00RV00 Rank: R-GP09-V2 Run No: 094822-054 Qt'y: 500[pcs] LG Innotek Co., Ltd. 80mm Run No. Indication 3 5 6 10 Code Manufacture Manufacture Manufacture Manufacture TH# Serial No Site Year Month date Paju : 1 2014:4 (01~31) $(00 \sim 99)$ $(00 \sim ZZ)$ 10 : A 11 : B 12 : C Huizhou: 9 2020 : 0 2021 : 1

### 8. Packing and Labeling of Products

### 8-2. Package and Label Structure

#### Label C

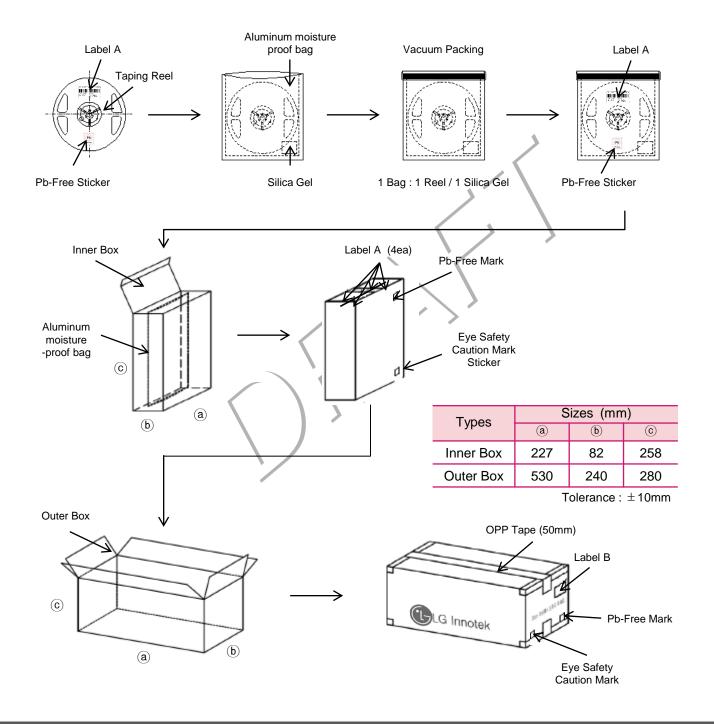
Specifying Customer, Date, Model Name, Quantity, Customer Part Number, Outbox ID, Rank/Rank Quantity



### 8. Packing and Labeling of Products

### 8-3. Packing Specifications

Reeled products (Numbers of products are Max.500pcs) packed in a sealed-off and moisture-proof aluminum bag with desiccants (Silica Gel). A Maximum four aluminum bags are packed in an inner box and six inner boxes are packed in an outer box. (Total Max. number of products are 12,000pcs)



#### 9. Cautions on Use

#### 9-1. Moisture-Proof Package

- -. The moisture in the SMD package may vaporize and expand during soldering.
- -. The moisture can damage the optical characteristics of the LEDs due to the encapsulation.

#### 9-2. During Storage

Conditions		Temperature	Humidity	Time
Before Opening Aluminum Bag Storage		5℃ ~ 30℃	< 50%RH	Within 1 Year from the Delivery Date
Clorage	After Opening Aluminum Bag	5℃ ~ 30℃	< 60%RH	≤ 672 hours
	Baking	65 ± 5℃	< 10%RH	10 ~ 24 hours

#### 9-3. During Usage

- -. The LED should avoid direct contact with hazardous materials such as sulfur, chlorine, phthalate, etc.
- -. The metal parts on the LED can rust when exposed to corrosive gases. Therefore, exposure to corrosive gases must be avoided during operation and storage.
- -. The silver-plated metal parts also can be affected not only by the corrosive gases emitted inside of the end-products but by the gases penetrated from outside environment.
- -. Extreme environments such as sudden ambient temperature changes or high humidity that can cause condensation must be avoided.

#### 9-4. Cleaning

- -. Do not use brushes for cleaning or organic solvents (i.e. Acetone, TCE, etc..) for washing as they may damage the resin of the LEDs.
- -. Isopropyl Alcohol(IPA) is the recommended solvent for cleaning the LEDs under the following conditions.
  - Cleaning Condition: IPA, 25°C max. × 60sec max.
- -. Ultrasonic cleaning is not recommended.
- -. Pretests should be conducted with the actual cleaning process to validate that the process will not damage the LEDs.

### 9. Cautions on Use

### 9-5. Thermal Management

- -. The thermal design of the end product must be seriously considered, particularly at the beginning of the system design process.
- -. The generation of heat is greatly impacted by the input power, the thermal resistance of the circuit boards and the density of the LED array combined with other components.

#### 9-6. Static Electricity

- Wristbands and anti-electrostatic gloves are strongly recommended and all devices, equipment and machinery must be properly grounded when handling the LEDs, which are sensitive against static electricity and surge.
- -. Precautions are to be taken against surge voltage to the equipment that mounts the LEDs.
- -. Unusual characteristics such as significant increase of current leakage, decrease of turn-on voltage, or non-operation at a low current can occur when the LED is damaged.

### 9-7. Electrostatic Discharge (ESD)

- The LEDs are sensitive to static electricity or surge voltage and current.

The Electrostatic Discharge can damage a LED Chip.

Also, It can be affect a reliability belong to the life time of LED package.

When handling LEDs, the following measures against ESD are actively recommended:

- 1) Please wear a wrist strap, anti-static clothes, foot wear and gloves.
- 2) Please set up a grounded or anti-static paint floors, a grounded or the ability to surge protection -workstation equipment and tools.
- 3) ESD protection- worktable/bench, mat made of a conductive materials.
- An appropriate grounding is required for all devices, equipment, and machinery used in product assembly.

Please apply surge protection after review when designing of commercial products(Curing Module, etc).

- If tools or equipment contain insulating materials such as glass or plastics,

the following measures against ESD are strongly recommended:

- 1) Dissipating static charge with conductive materials
- Preventing charge generation with moisture
- 3) Plug in the ionizing blowers(ionizer) for neutralizing the charge
- The customer is advised to check if the LEDs are damaged by ESD when performing the characteristics inspection of the LEDs in the application.

Damage of LED can be detected with a forward voltage checking(measuring) at low current(≤1mA).

- ESD damaged LEDs may have a current flow at a low voltage.
  - \* Failure Criteria : V<sub>F</sub> < 2.0V at If= 0.5mA.



#### 9. Cautions on Use

#### 9-8. Recommended Circuit

- -. The current through each LED must not exceed the absolute maximum rating when designing the circuits.
- -. In general, there can be various forward voltages for LEDs. Different forward voltages in parallel via a single resistor can result in different forward currents to each LED, which also can output different luminous flux values. In the worst case, the currents can exceed the absolute maximum ratings which can stress the LEDs. Matrix circuit with a single resistor for each LED is recommended to avoid the luminous flux fluctuations.

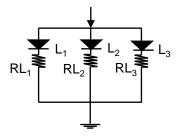


Fig.1. Recommended Circuit in Parallel Mode : Separate resistors must be used for each LED.

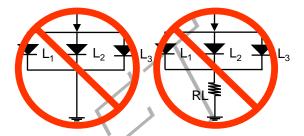


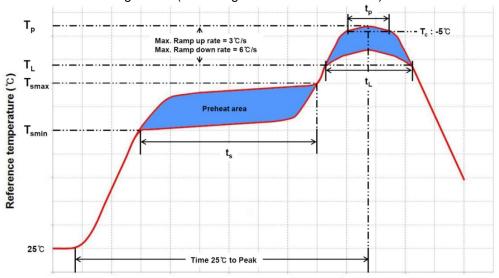
Fig.2. Abnormal Circuit:
Avoid this circuits! The current through the LEDs may vary due to the variation in LED forward voltage.

- -. The driving circuits must be designed to operate the LEDs by forward bias only.
- -. Reverse voltages can damage the zener diode, which can cause the LED to fail.
- -. A constant current LED driver is recommended to power the LEDs.

#### 9. Cautions on Use

#### 9-9. Soldering Conditions

- -. Reflow soldering is the recommended method for assembling LEDs on a circuit board.
- -. LG Innotek does not guarantee the performance of the LEDs assembled by the dip soldering method.
- -. Recommended Soldering Profile (according to JEDEC J-STD-020D)



Time	(sec)

Profile Feature	Pb-Free Assembly	Pb-Based Assembly
$\begin{array}{c} \text{Preheat / Soak} \\ \text{Temperature Min } (T_{\text{smin}}) \\ \text{Temperature Max } (T_{\text{smax}}) \\ \text{Maximum time} (t_{\text{s}}) \text{ from } T_{\text{smin}} \text{ to } T_{\text{smax}} \end{array}$	150°C 200°C 60~120 seconds	100℃ 150℃ 60~120 seconds
Ramp-up rate $(T_L \text{ to } T_p)$	3°C/ second max.	3°C/ second max.
Liquidous temperature (T <sub>L</sub> )	217℃	183℃
Time $(t_L)$ maintained above $T_L$	60~150 seconds	60~150 seconds
Maximum peak package body temperature (T <sub>p</sub> )	260℃	235℃
Time( $t_p$ ) within 5 $^{\circ}$ C of the specified temperature ( $T_c$ )	30 seconds	20 seconds
Ramp-down rate (T <sub>p</sub> to T <sub>L</sub> )	6℃/second max.	6℃/second max.
Maximum Time 25 ℃ to peak temperature	8 minutes max.	6 minutes max.

- -. Reflow or hand soldering at the lowest possible temperature is desirable for the LEDs although the recommended soldering conditions are specified in the above diagrams.
- -. A rapid cooling process is not recommended for the LEDs from the peak temperature.
- -. The silicone encapsulant at the top of the LED package is a soft surface, which can easily be damaged by pressure. Precautions should be taken to avoid strong pressure on the silicone resin when leveraging the pick and place machines.
- -. Reflow soldering should not be done more than two times.

### 9. Cautions on Use

### 9-10. Soldering Iron

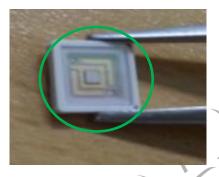
- -. The recommended condition is less than 5 seconds at 260  $^{\circ}$ C.
- -. The time must be shorter for higher temperatures. (+10  $^{\circ}$ C  $\rightarrow$  -1sec).
- -. The power dissipation of the soldering iron should be lower than 15W and the surface temperature of the device should be controlled at or under 230 °C.

#### 9-11. Eye Safety Guidelines

- -. Do not directly look at the light when the LEDs are on.
- -. Proceed with caution to avoid the risk of damage to the eyes when examining the LEDs with optical instruments.

#### 9-12. Manual Handling

-. Use Teflon-type tweezers to grab the base of the LED and do not apply mechanical pressure on the surface of the encapsulant.





### 10. Disclaimers

- -. LG Innotek is not responsible for any damages or accidents caused if the operating or storage conditions exceed the absolute maximum ratings recommended in this document.
- -. The LEDs described in this document are intended to be operated by ordinary electronic equipment.
- -. It is recommended to consult with LG Innotek when the environment or the LED operation is non-standard in order to avoid any possible malfunctions or damage to product or risk of life or health.
- Disassembly of the LED products for the purpose of reverse engineering is prohibited without prior written consent from LG Innotek. All defected LEDs must be reported to LG Innotek and are not to be disassembled or analyzed.
- -. The product information can be modified and upgraded without prior notice.

## History of Revision

Revision	Date	Contents Revision	Remark
		4	
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